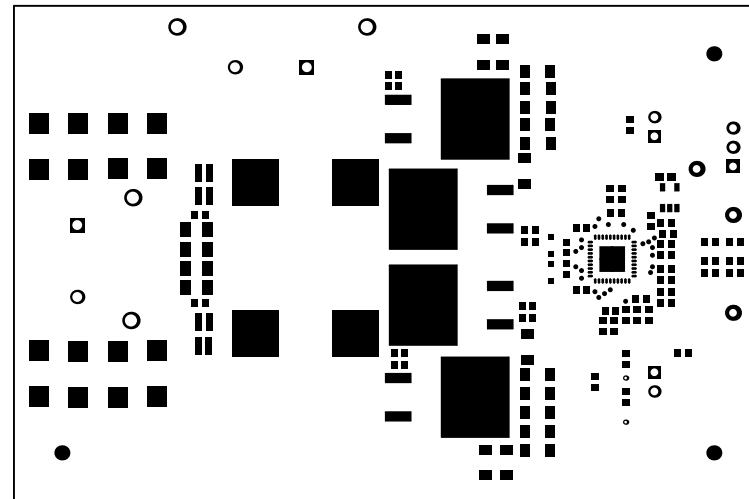
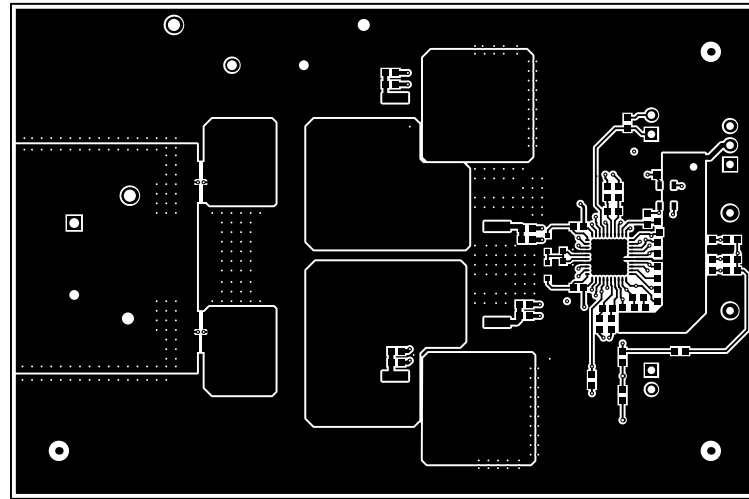


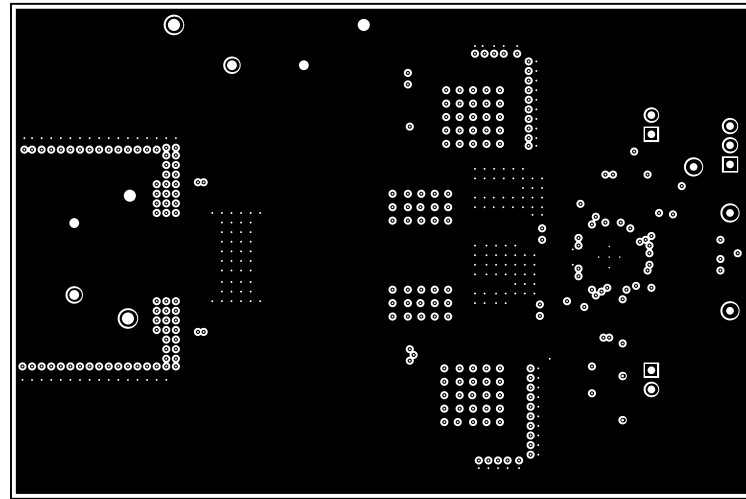
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | TID #: PMP15032 | | |
| PLOT NAME = Top Overlay | GENERATED : 6/16/2017 1:54:50 PM | TEXAS INSTRUMENTS | |



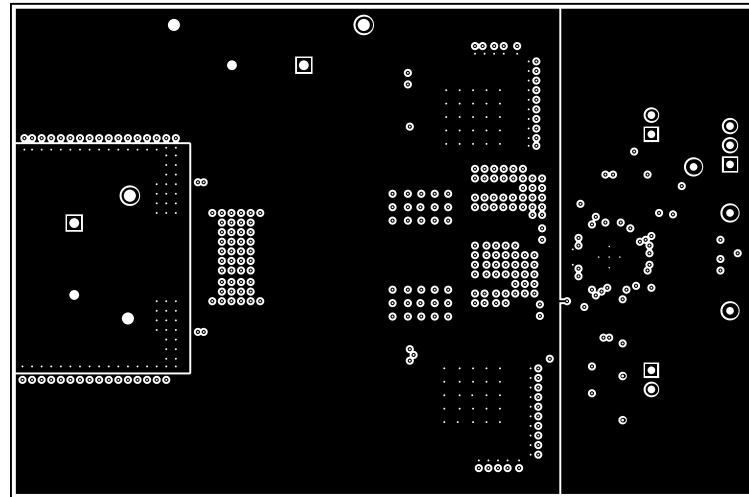
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | TID #: PMP15032 | | |
| PLOT NAME = Top Solder Mask | GENERATED : 6/16/2017 1:54:50 PM | TEXAS INSTRUMENTS | |



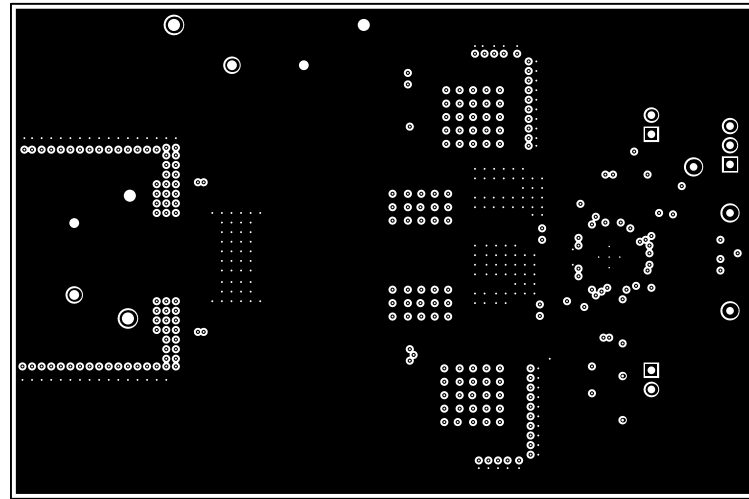
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | TID #: PMP15032 | | |
| PLOT NAME = Top Layer | GENERATED : 6/16/2017 1:54:51 PM | TEXAS INSTRUMENTS | |



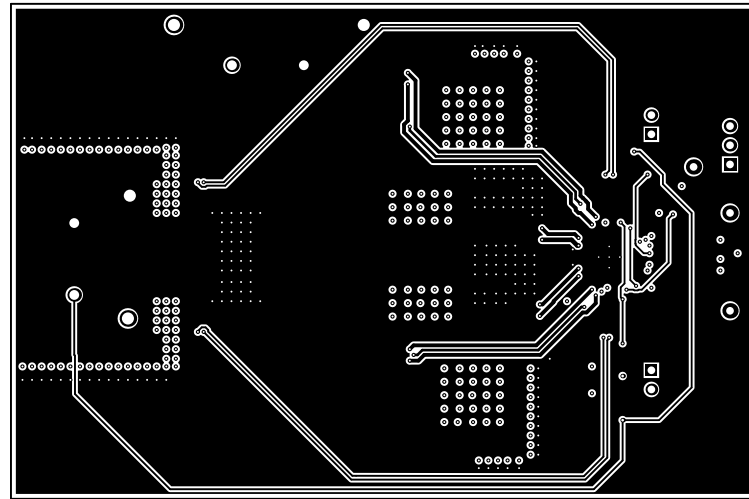
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Signal Layer 1 | TID #: PMP15032 | | |
| PLOT NAME = Signal Layer 1 | GENERATED : 6/16/2017 1:54:52 PM | TEXAS INSTRUMENTS | |



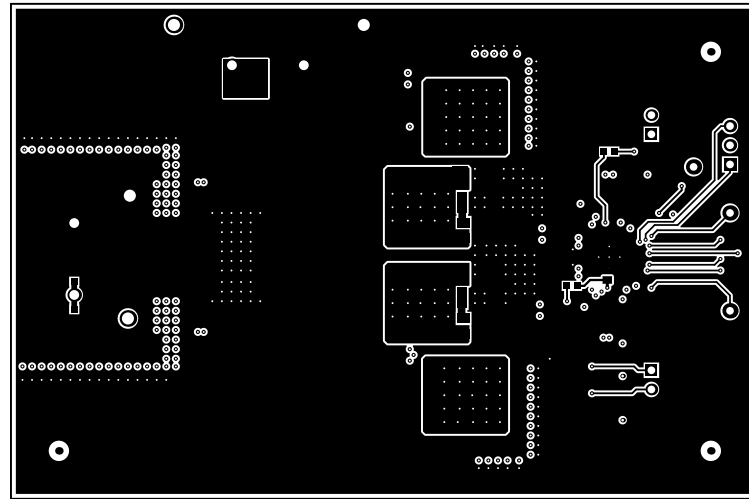
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Signal Layer 2 | TID #: PMP15032 | | |
| PLOT NAME = Signal Layer 2 | GENERATED : 6/16/2017 1:54:52 PM | TEXAS INSTRUMENTS | |



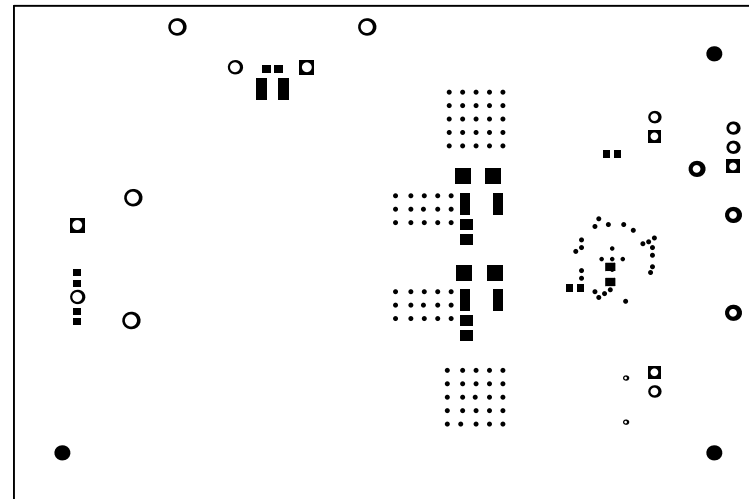
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Signal Layer 3 | TID #: PMP15032 | | |
| PLOT NAME = Signal Layer 3 | GENERATED : 6/16/2017 1:54:53 PM | TEXAS INSTRUMENTS | |



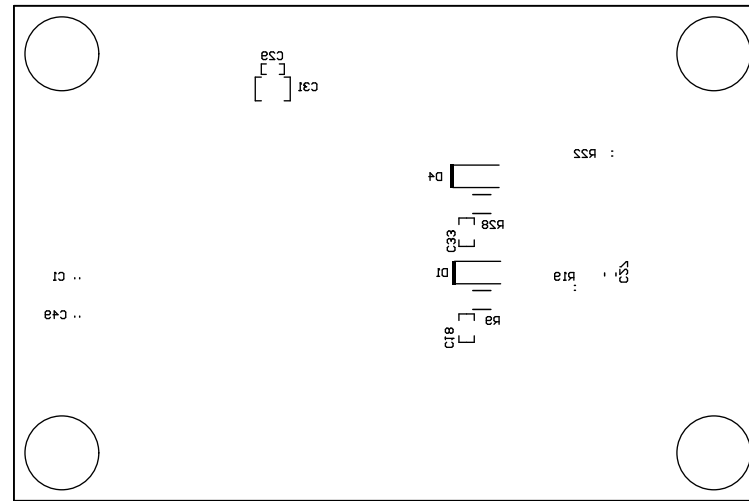
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Signal Layer 4 | TID #: PMP15032 | | |
| PLOT NAME = Signal Layer 4 | GENERATED : 6/16/2017 1:54:54 PM | TEXAS INSTRUMENTS | |



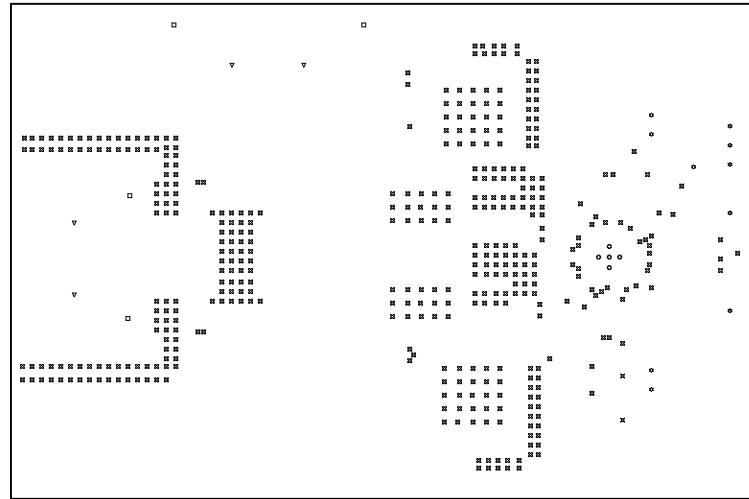
| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | TID #: PMP15032 | | |
| PLOT NAME = Bottom Layer | GENERATED : 6/16/2017 1:54:55 PM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | TID #: PMP15032 | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 6/16/2017 1:54:55 PM | TEXAS INSTRUMENTS | |

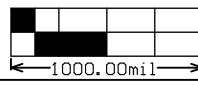
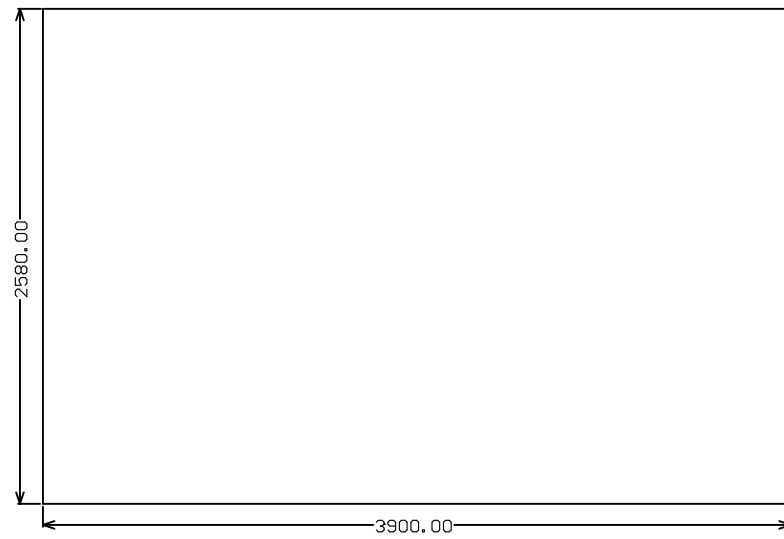


| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | TID #: PMP15032 | | |
| PLOT NAME = Bottom Overlay | GENERATED : 6/16/2017 1:54:56 PM | TEXAS INSTRUMENTS | |



| Symbol | Quantity | Finished Hole Size | Plated | Hole Type | Drill Layer Pair | Hole Tolerance |
|--------|-----------|--------------------|--------|-----------|--------------------------|----------------|
| ⊗ | 5 | 7.87mil (0.200mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 422 | 10.00mil (0.254mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 2 | 14.00mil (0.356mm) | PTH | Round | Top Layer - Bottom Layer | |
| ⊗ | 10 | 40.00mil (1.016mm) | PTH | Round | Top Layer - Bottom Layer | |
| ▽ | 4 | 51.18mil (1.300mm) | PTH | Round | Top Layer - Bottom Layer | |
| □ | 4 | 63.00mil (1.600mm) | PTH | Round | Top Layer - Bottom Layer | |
| | 447 Total | | | | | |

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | TID #: PMP15032 | | |
| PLOT NAME = Drill Drawing | GENERATED : 6/16/2017 1:54:57 PM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: PMP15032 | REV: A | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | TID #: PMP15032 | | |
| PLOT NAME = Board Dimensions | GENERATED : 6/16/2017 1:54:58 PM | TEXAS INSTRUMENTS | |

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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